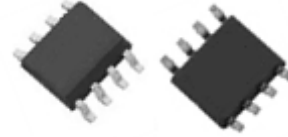


Description

SSC4S701 is a single channel low-side gate driver, and drives a power transistor such as an IGBT and a power MOSFET. The IC has the undervoltage lockout for power supply and the overcurrent protection. When these protections are activated, the IC outputs the fault signal whose width is adjustable by an external capacitor.

The IC is provided in the compact and low profile SOIC8 package.

Package
 SOIC8



Not to scale

Features

- Single Input and Output
- Fault Signal Output at Abnormal Condition
- Adjustable Fault Signal Output Time
- Protections
 - Undervoltage Lockout for Power Supply
 - Overcurrent Protection

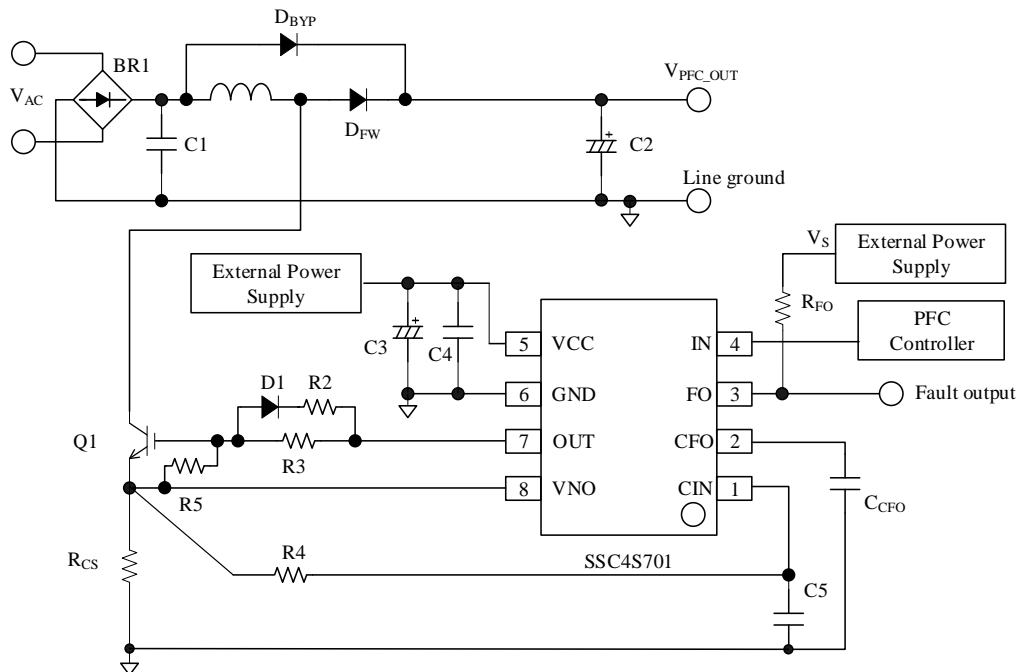
Specifications

- Power Supply Voltage, V_{CC} : 24 V
 (Recommended Value is 15 V)
- OUT Pin Peak Source Current: -0.8 A
- OUT Pin Peak Sink Current: 1.75 A

Applications

- Inverter Air Conditioners
- Refrigerators
- Industrial Equipment
- Server, etc.

Typical Application



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1. Absolute Maximum Ratings

Current polarities are defined as follows: current going into the IC (sinking) is positive current (+); current coming out of the IC (sourcing) is negative current (-).

Unless otherwise specified, $T_A = 25\text{ }^\circ\text{C}$.

Parameter	Symbol	Conditions	Pins	Rating	Unit
CIN Pin Voltage	V_{CIN}		1 – 6	-0.3 to 7	V
CFO Pin Voltage	V_{CFO}		2– 6	-0.3 to 7	V
FO Pin Voltage	V_{FO}		3 – 6	-0.3 to 7	V
FO Pin Current	I_{FO}		3 – 6	1.0	mA
IN Pin Voltage	V_{IN}		4 – 6	-0.3 to 7	V
VCC Pin Voltage	V_{CC}		5 – 6	-0.3 to 24	V
OUT Pin Voltage	V_{OUT}		7 – 6	$V_{NO} - 0.3$ to $V_{CC} + 0.3$	V
OUT Pin Peak Source Current	$I_{OUT(SRC)}$		7 – 6	-0.8	A
OUT Pin Peak Sink Current	$I_{OUT(SNK)}$		7 – 6	1.75	A
VNO Pin Voltage	V_{NO}		8 – 6	-5 to $V_{CC} + 0.3$	V
Power Dissipation	P_D		—	0.78	W
Operating Ambient Temperature	T_{OP}		—	-40 to 100	$^\circ\text{C}$
Storage Temperature	T_{STG}		—	-40 to 150	$^\circ\text{C}$
Junction Temperature	T_J		—	150	$^\circ\text{C}$

2. Recommended Operating Range

Current polarities are defined as follows: current going into the IC (sinking) is positive current (+); current coming out of the IC (sourcing) is negative current (-).

Unless otherwise specified, $T_A = 25\text{ }^\circ\text{C}$.

Parameter	Symbol	Conditions	Min.	Max.	Unit
IN Pin Voltage	V_{IN}	$V_{CC} = 15\text{ V}$	0	5	V
VCC Pin Voltage	V_{CC}		13.5	16.5	V
VNO Pin Voltage	V_{NO}	$V_{CC} = 15\text{ V}$	-5	5	V

3. Electrical Characteristics

Current polarities are defined as follows: current going into the IC (sinking) is positive current (+); current coming out of the IC (sourcing) is negative current (-).

Unless otherwise specified, $T_A = 25\text{ }^\circ\text{C}$, $V_{CC} = 15\text{ V}$ and $V_{NO} = 0\text{ V}$.

Parameter	Symbol	Conditions	Pins	Min.	Typ.	Max.	Unit
Power Supply Operation							
Operation Start Voltage	$V_{CC(ON)}$	The FO pin increases low- to high- level, or decreases high- to low-level. $R_{FO} = 5\text{ k}\Omega$, $V_S = 5\text{ V}$	5 – 6	11.20	11.90	12.70	V
Operation Stop Voltage	$V_{CC(OFF)}$		5 – 6	—	11.40	—	V
Operation Start Stop Hysteresis	$V_{CC(HYS)}$		5 – 6	—	0.50	—	V
Circuit Current in Operation	$I_{CC(ON)}$	$V_{IN} = 0\text{ V}$	5 – 6	—	0.40	1.70	mA
Filtering Time	t_{VCC_UV}	V_{CC} decreases 15 V to 10 V.	5 – 6	—	10	—	μs
CIN Pin Operation							
CIN Trip Voltage	V_{CIN}	The FO pin increases low- to high- level, or decreases high- to low-level.	1 – 6	0.45	0.50	0.55	V
CIN Voltage Delay Time	t_{CIN_1}	See Figure 3-1.	1 – 6	—	—	500	ns
CIN Filtering Time	t_{CIN_2}	The CIN pin maximum pulse width that the FO pin does not response. See Figure 3-1.	1 – 6	80	180	240	ns
CFO Pin Operation							
Fault Output Time	t_{WFOP}	$C_{CFO} = 1\text{ nF}$	2 – 6	75	110	180	μs
CFO Threshold Voltage	V_{CFH}	The FO pin increases low- to high- level.	2 – 6	2.4	2.7	3.0	V
CFO Pin Source Current	I_{CFO}	$V_{CFO} = 0\text{ V}$	2 – 6	-40	-25	-15	μA
FO Pin Operation							
FO Pin High Level Output Voltage	V_{FOH}	$V_{CIN} = 0\text{ V}$, $R_{FO} = 5\text{ k}\Omega$, $V_S = 5\text{ V}$	3 – 6	4.50	5.00	—	V
FO Pin Low Level Output Voltage	V_{FOL}	$V_{CIN} = 1\text{ V}$, $I_{FO} = 1\text{ mA}$	3 – 6	—	—	0.95	V
FO Pin Leakage Current	I_{FO}	$V_{CIN} = 0\text{ V}$, $V_{FO} = 5\text{ V}$	3 – 6	—	—	1.0	μA
IN Pin Operation							
High Level Input Threshold Voltage	V_{INH}	The OUT pin increases low- to high- level.	4 – 6	—	2.10	2.60	V
Low Level Input Threshold Voltage	V_{INL}	The OUT pin decreases high- to low-level.	4 – 6	—	1.30	—	V
Input Hysteresis Voltage	V_{INHYS}		4 – 6	0.35	0.80	—	V
Input Pull-down Current	I_{IN}	$V_{IN} = 5\text{ V}$	4 – 6	0.24	0.33	0.50	mA
OUT Pin Operation							
High Level Output Threshold Voltage	V_{OUTH}	$I_{OUT} = 0\text{ mA}$	7 – 6	14.50	15.00	—	V
Low Level Output Threshold Voltage	V_{OUTL}	$I_{OUT} = 0\text{ mA}$	7 – 6	—	0.00	0.10	V
Turn-on Delay Matching	t_{dLH}	$C_{OUT} = 1000\text{ pF}$, see Figure 3-2	7 – 6	—	—	300	ns

SSC4S701

Parameter	Symbol	Conditions	Pins	Min.	Typ.	Max.	Unit
Turn-off Delay Matching	t_{dHL}	$C_{OUT} = 1000 \text{ pF}$, see Figure 3-2	7 - 6	—	—	300	ns
Output Rise Time	t_r	$C_{OUT} = 1000 \text{ pF}$, see Figure 3-2	7 - 6	—	—	150	ns
Output Fall Time	t_f	$C_{OUT} = 1000 \text{ pF}$, see Figure 3-2	7 - 6	—	—	75	ns
VNO Pin Operation							
VNO Pin Current 1	I_{VNO1}	$V_{NO} = -5 \text{ V}$	8 - 6	-7.0	-5.0	-3.0	mA
VNO Pin Current 2	I_{VNO2}	$V_{CC} = 24 \text{ V}$, $V_{NO} = 15 \text{ V}$	8 - 6	—	15	—	μA

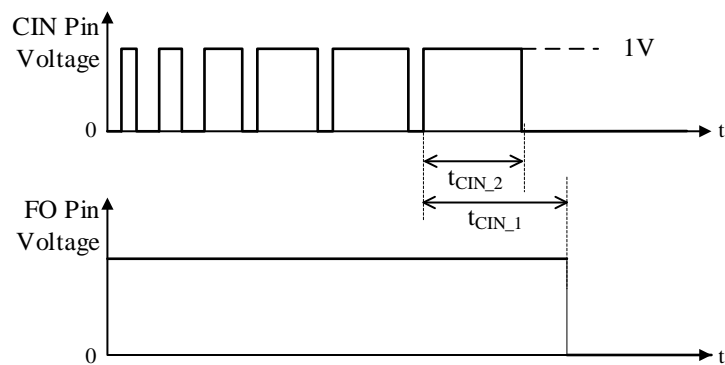


Figure 3-1. CIN Voltage Delay Time and CIN Filtering Time

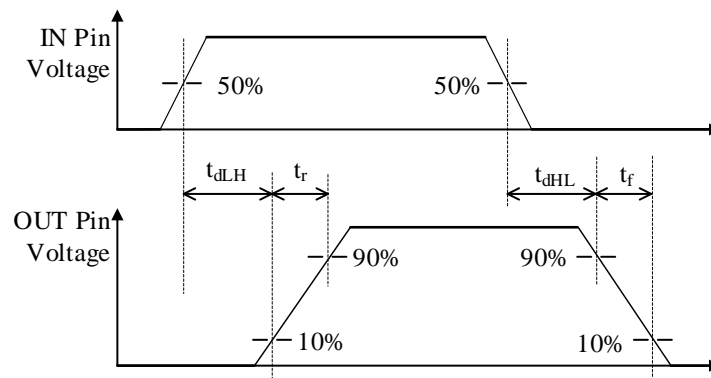


Figure 3-2. Input and Output Waveforms

4. Performance Curves

4.1. Thermal Derating Curve

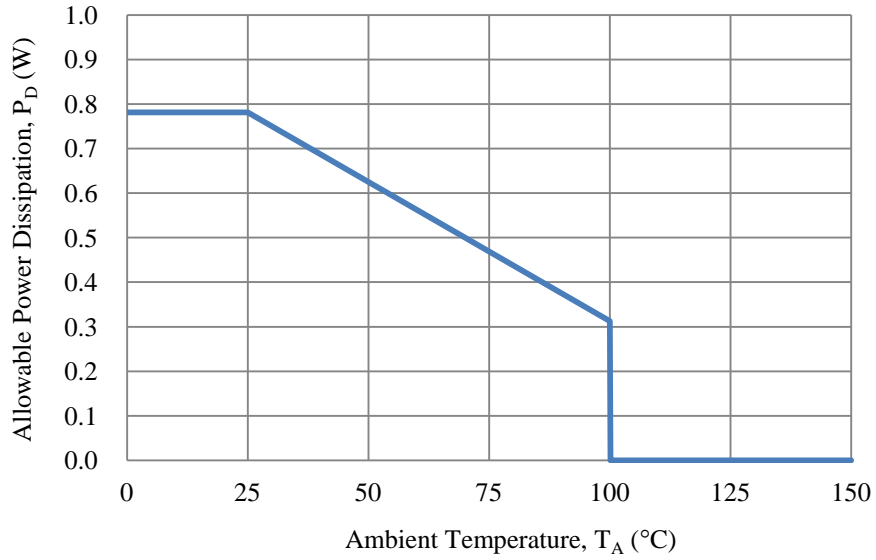
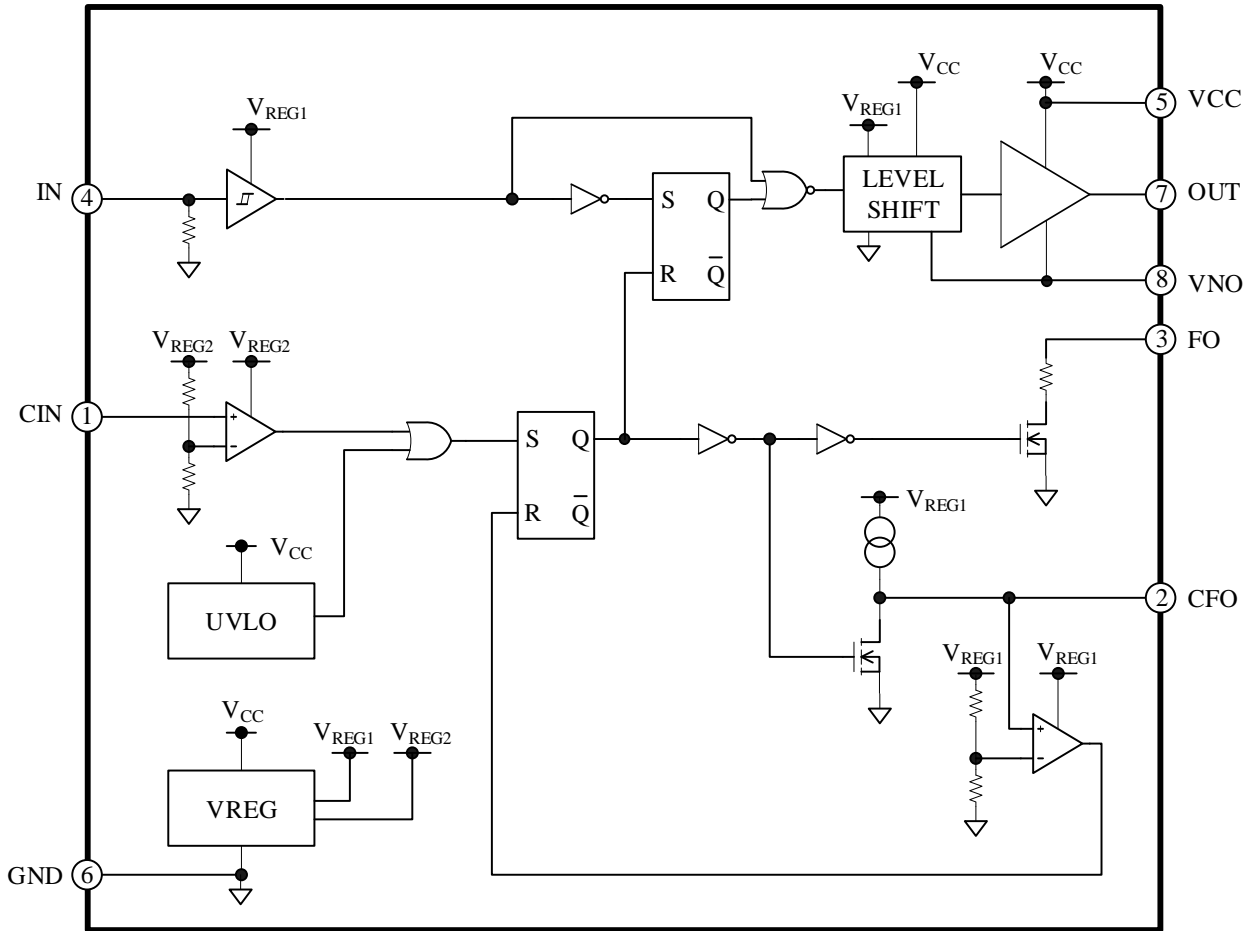
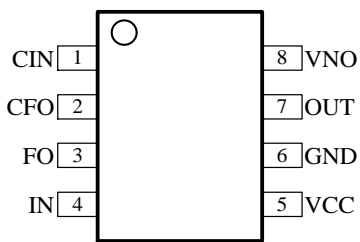


Figure 4-1. Thermal Derating Curve

5. Block Diagram



6. Pin Configuration Definitions



Pin Number	Pin Name	Description
1	CIN	Input for overcurrent protection
2	CFO	Capacitor connection for setting a fault signal output time
3	FO	Fault signal output
4	IN	Signal input
5	VCC	Power supply input
6	GND	Ground
7	OUT	Gate drive signal output
8	VNO	Drive current return pin (For example, IGBT emitter is connected)

7. Typical Application

Figure 7-1 shows the PFC circuit example using the SSC4S701.

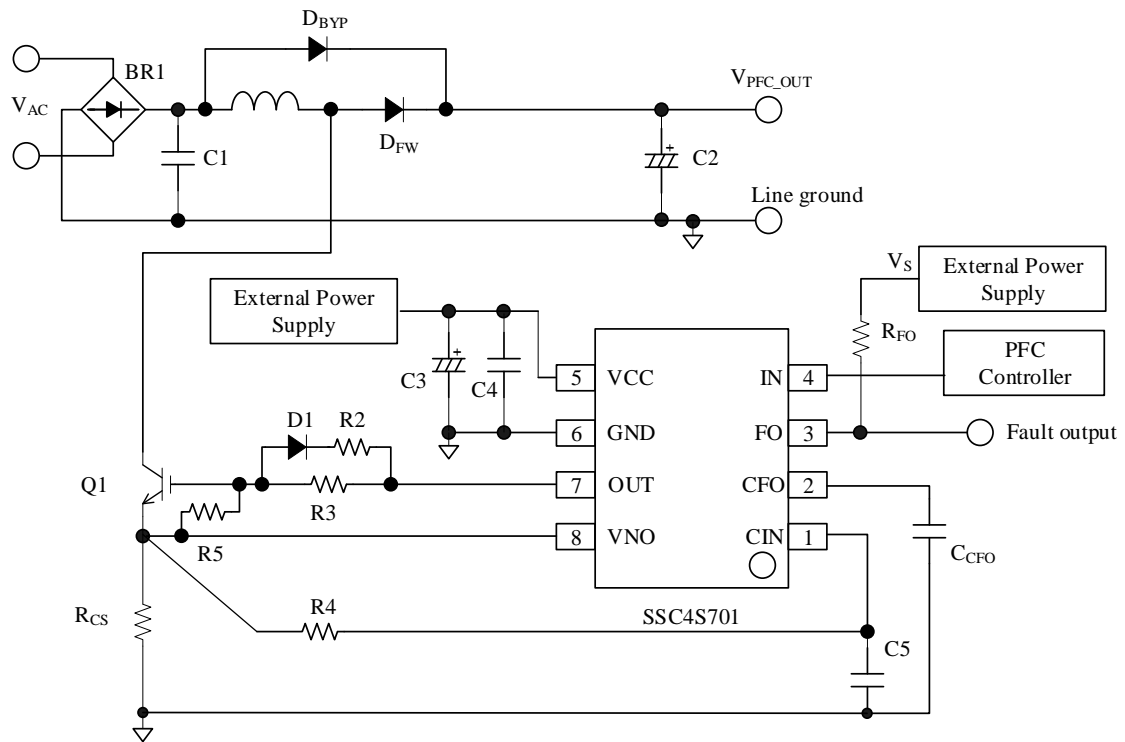
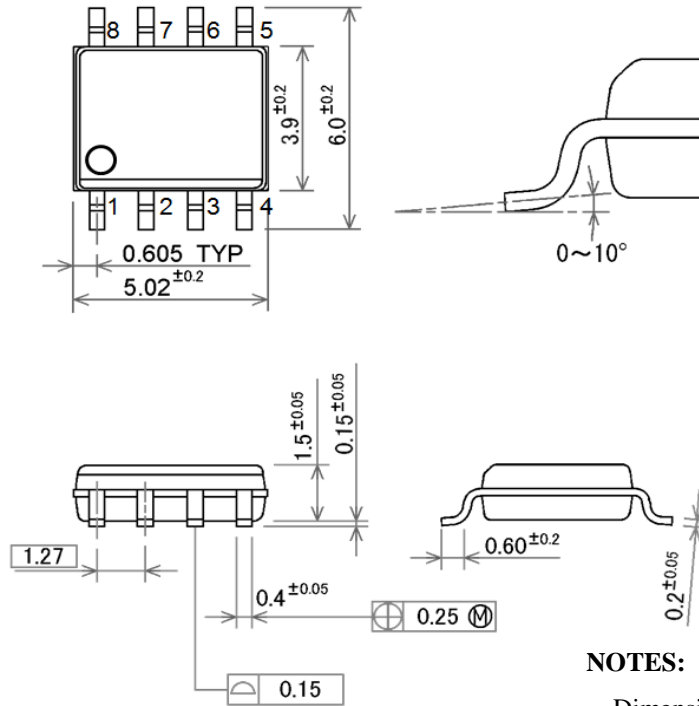


Figure 7-1. PFC Circuit Example Using SSC4S701

8. Physical Dimensions

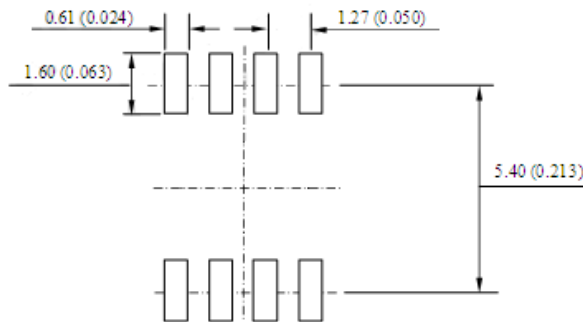
• SOIC8 Package



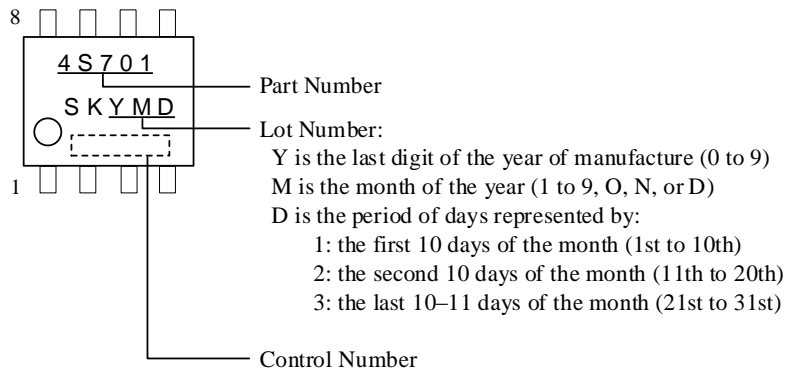
NOTES:

- Dimensions in millimeters
- Pb-free

• SOIC8 Land Pattern Example



9. Marking Diagram



10. Operational Description

All the characteristic values given in this section are typical values, unless they are specified as minimum or maximum. Current polarities are defined as follows: current going into the IC (sinking) is positive current (+); current coming out of the IC (sourcing) is negative current (-).

Figure 10-1 shows the SSC4S701 peripheral circuit and the meaning of the symbols used in Section 10.

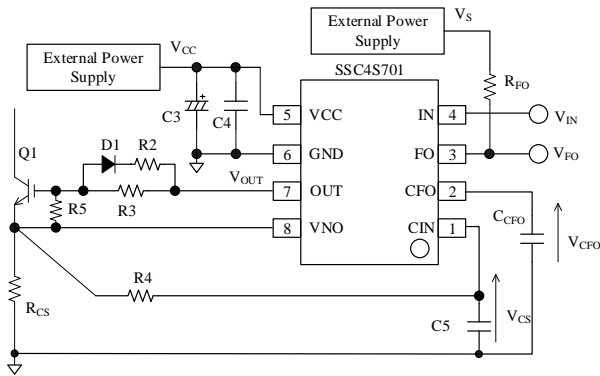


Figure 10-1. SSC4S701 Peripheral Circuit

10.1. Fault Signal Output

When the undervoltage lockout for power supply or the overcurrent protection is activated, the FO pin outputs the fault signal that is low level. Then, the capacitor, CCF0, connected to the CFO pin is charged by the CFO Pin Source Current, ICFO. When a CFO pin voltage, VCF0, increases to the CFO Threshold Voltage, VCFH, CCF0 is discharged. If the fault condition is removed during the fault output time, tWFOP, the FO pin becomes high level. Then, a OUT pin signal, VOUT, operates according to an input signal, VIN.

The fault output time, tWFOP, is determined by the value of CCF0. The approximate value of tWFOP is calculated by the following equation.

$$t_{WFOP} = \frac{C_{CFO} \times V_{CFH}}{|I_{CFO}|} \quad (1)$$

where:

C_{CFO} is the CFO pin capacitor value,
 V_{CFH} is the CFO Threshold Voltage (= 2.7 V), and
 I_{CFO} is the CFO Pin Source Current (= -25 μA).

The FO pin should be connected to an external power supply by the pull-up resistor, RFO. If the external power supply voltage is 5 V, RFO is about 5 kΩ.

10.2. Startup Operation

Figure 10-2 and Figure 10-3 show the startup waveforms. The VCC pin voltage, VCC, is added from an external power supply.

While VCC increases to the internal circuit start voltage from 0 V (period A described in Figure 10-2 and Figure 10-3), the FO pin voltage becomes V_F + VCC (where V_F is a forward voltage of an internal protection diode). When the internal circuit operates, the FO pin becomes low level and outputs the fault signal. If VCC is the Operation Start Voltage, VCC(ON), or more for the fault output time, tWFOP, the IC discharges CCF0, and turns the FO pin status into high (see Figure 10-2).

The approximate value of the fault output time, tWFOP, is calculated by Equation (1) (see Section 10.1).

On the other hand, when VCC is less than VCC(ON) for the fault output time, tWFOP, the IC keeps to charge CCF0 until VCC increases to ≥ VCC(ON) (see Figure 10-3). When VCC becomes ≥ VCC(ON), the IC discharges CCF0, and turns the FO pin status into high. Then, the OUT pin outputs the signals according to the IN pin signal after the next rising edge of an IN pin signal.

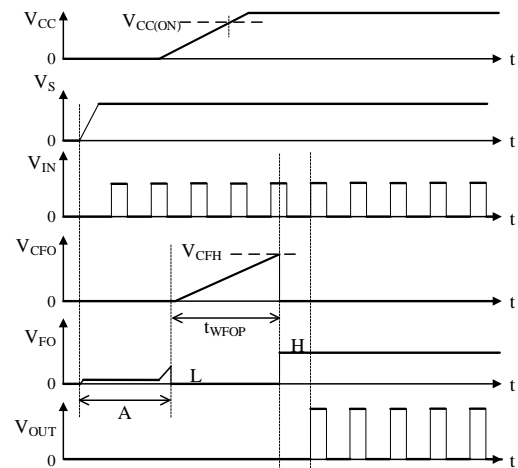


Figure 10-2. Startup Waveforms 1

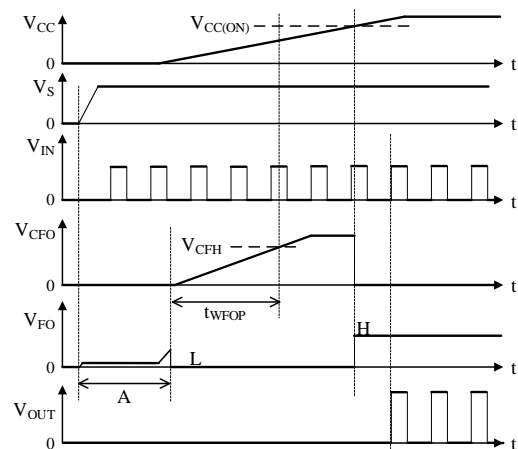


Figure 10-3. Startup Waveforms 2

10.3. Undervoltage Lockout for Power Supply

The undervoltage lockout (UVLO) circuit for power supply has a filter circuit to prevent the malfunction caused by the rapid decrease of the power supply, which is caused by noise, etc. The Filtering Time, t_{VCC_UV} , is 10 μ s.

Figure 10-4 shows the UVLO operational waveforms. The UVLO is activated when all the following conditions are fulfilled.

- The VCC pin voltage, V_{CC} , decreases to the Operation Stop Voltage, $V_{CC(OFF)}$, or less after the IC operates.
- Then, V_{CC} remains less than the Operation Start Voltage, $V_{CC(ON)}$ for t_{VCC_UV} .

While the UVLO is activated, the IC turns the FO pin status into low, and stops the output of the OUT pin signal. The subsequent operations are explained in Section 10.1.

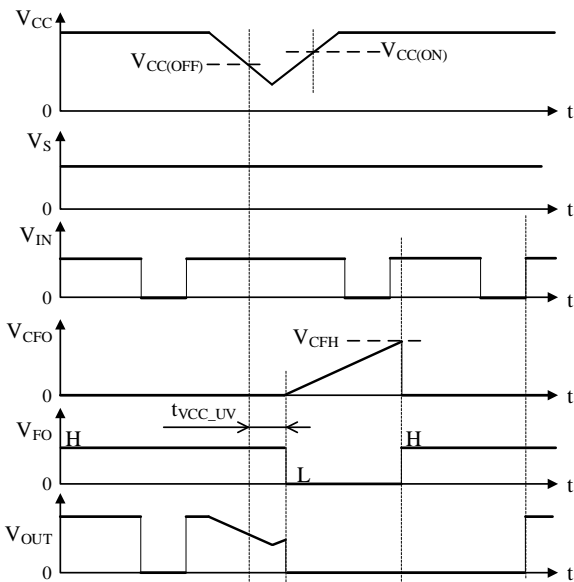


Figure 10-4. Undervoltage Lockout for Power Supply Operational Waveforms

10.4. Overcurrent Protection

The CIN pin is the input of overcurrent signals. When the CIN pin detects the voltage of $\geq V_{CIN}$ for $\geq t_{CIN_2}$, the overcurrent protection is activated after t_{CIN_1} . Where: V_{CIN} is the CIN Trip Voltage of 0.50 V, t_{CIN_2} is the CIN Filtering Time of 180 ns, and t_{CIN_1} is the CIN Voltage Delay Time of 500 ns (max.).

While the overcurrent protection is activated, the IC turns the FO pin status into low, and stops the output of the OUT pin signal. When the CIN pin voltage decreases to $< V_{CIN}$ for the fault output time, t_{WFOP} , from overcurrent protection activation, the IC discharges C_{CFO} ,

and turns the FO pin status into high (see Figure 10-5). The approximate value of t_{WFOP} is calculated by Equation (1) (see Section 10.1).

On the other hand, when the CIN pin voltage is more than V_{CIN} for t_{WFOP} , the IC keeps to charge C_{CFO} until the CIN pin voltage decreases to $< V_{CIN}$ (see Figure 10-6). When the CIN pin voltage becomes $< V_{CIN}$, the IC discharges C_{CFO} , and turns the FO pin status into high. Then, the OUT pin outputs the signals according to the IN pin signal after the next rising edge of an IN pin signal.

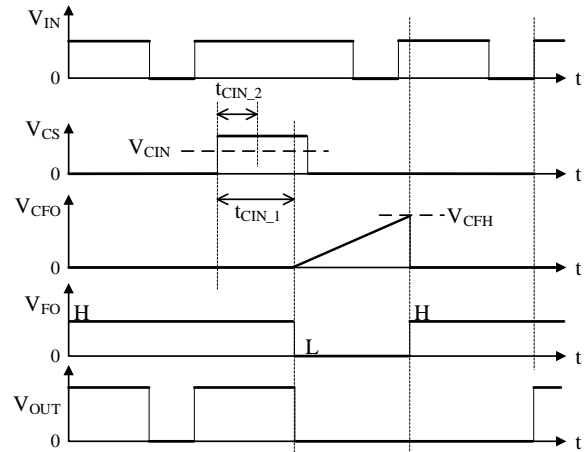


Figure 10-5. Overcurrent Protection Operational Waveforms 1

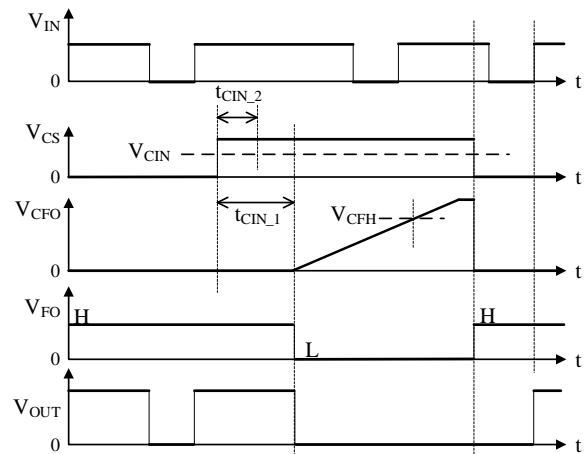


Figure 10-6. Overcurrent Protection Operational Waveforms 2

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